

Palm Springs, USA, 14-16 March 2001

Source: Rapporteur

Title: Status report on Work Item of LCRTDD-L23

Agenda: 6.7.2

This document provides a status report of the work item ‘Low chip rate TDD layer2 and layer3 Protocol Aspects’ .

The Technical Report “UTRA TDD low chip rate option protocol aspects” was created in July 3rd-7th during RAN WG2#14 meeting and approved in RAN#10 meeting and the version of TR25.834 is 4.0.0.

During RAN WG2#18 meeting in Edinburgh, CRs on 25.301, 25.302, 25.304, 25.321 to capture the impact of 1.28 Mcps TDD were agreed and draft CRs to 25.331 were presented.

The CR to 25.302 was sent to RAN WG1 in a liaison statement for review. Comments resulting from the review were captured.

During RAN WG2#19 meeting, change requests to 25.331, 25.303 and a revision of the change request to 25.302 were presented and agreed. Furthermore, a change request to 25.834 in order to update the technical report with the latest changes was presented and agreed.

The following TR and CRs are completed for this work item:

TR25.834	V4.0.0
CR for 25.834	CR003
CR for 25.301	CR042
CR for 25.302	CR090
CR for 25.303	CR043
CR for 25.304	CR057
CR for 25.321	CR064
CRs for 25.331	CR706
	CR707
	CR708
	CR709

Work concerning work item “Low chip rate TDD layer 2 and layer 3 protocol aspects” is therefore finished within RAN WG2.